

### General Description

The SY20733B is a low-voltage, low-dropout voltage regulator capable of sourcing 500mA with a built-in negative metal-oxide-semiconductor (NMOS). A separate bias rail is provided to enable an input voltage range of 0.8V to 5.5V. The output voltage can be configured using a resistor divider and provides a voltage accuracy of  $\pm 1\%$ .

The SY20733B is available in a compact DFN1.2mm $\times$ 1.2mm-6 pin package.

### Features

- Input Voltage Range: 0.8V-5.5V
- Bias Voltage Range: 2.4V-5.5V
- Output Voltage Accuracy:  $\pm 1\%$
- Bias Input Quiescent Current: 110 $\mu$ A (typ.)
- Bias Shutdown current: 0.1 $\mu$ A (typ.)
- Up to 500mA Output Current
- Current Limit Protection
- Over Temperature Shutdown
- Output Auto-Discharge Resistor: 130 $\Omega$
- RoHS Compliant and Halogen Free
- Compact Package: DFN1.2 $\times$ 1.2-6

### Applications

- Battery-Powered Equipment
- Smartphones, Tablets
- Cameras, DVRs, STB and Camcorders

### Typical Applications

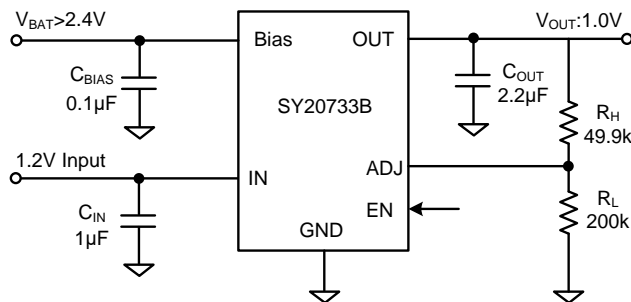


Figure 1. Schematic Diagram

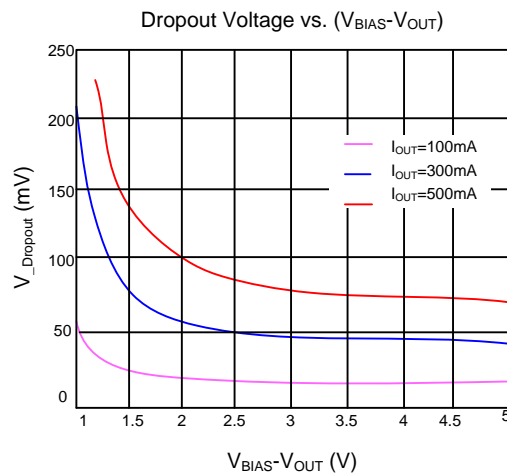


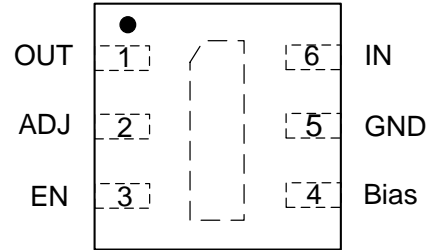
Figure 2. Dropout Curve

## Ordering Information

Ordering Part Number	Package Type	Top Mark
SY20733BSCC	DFN1.2x1.2-6 RoHS Compliant and Halogen Free	Hxyz

*x=year code, y=week code, z=lot number code*

## Pinout (top view)



Pin Number	Symbol	Pin Description
1	OUT	Output pin. Decouple this pin to the GND with at least a 2.2μF ceramic capacitor.
2	ADJ	Output voltage programming pin. Connect this pin to the center point of the output resistor divider (as shown in Figure 1) to program the output voltage: $V_{OUT}=0.8V \times (1+R_H/R_L)$ .
3	EN	Enable control pin. Pull high to enable the regulator. Pull low to shut down the regulator. Do not leave it floating.
4	Bias	Bias voltage supply for internal control circuits. Decouple this pin to GND with at least a 0.1μF ceramic capacitor.
5	GND	Ground pin.
6	IN	Input voltage supply pin. Decouple this pin to GND with at least a 1μF ceramic capacitor.

## Block Diagram

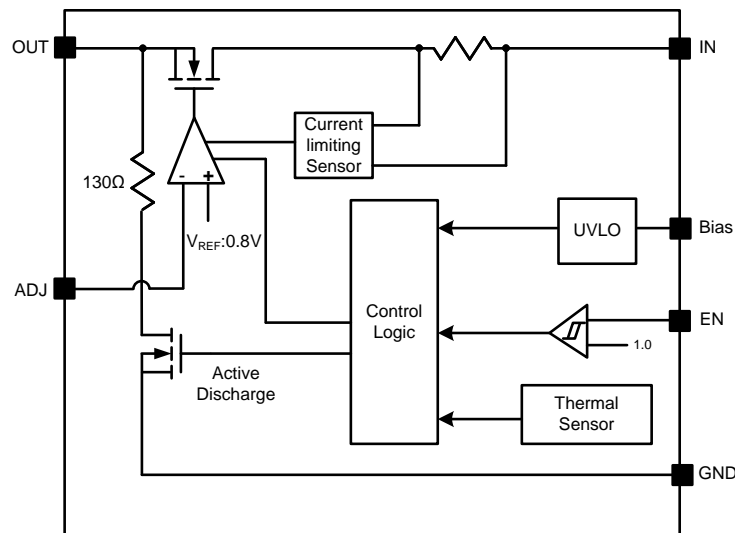


Figure 3. Block Diagram

**Absolute Maximum Ratings**

Parameter (Note1)	Min	Max	Unit
IN, OUT, Bias, EN, ADJ	-0.3	6	V
Lead Temperature (Soldering, 10 sec.)		260	
Junction Temperature, Operating	-40	150	°C
Storage Temperature	-65	150	

**Thermal Information**

Parameter (Note2)	Typ	Unit
$\theta_{JA}$ Junction-to-ambient Thermal Resistance	70	°C/W
$\theta_{JC}$ Junction-to-case Thermal Resistance	12	
$P_D$ Power Dissipation $T_A = 25^\circ\text{C}$	1.4	W

**Recommended Operating Conditions**

Parameter (Note 3)	Min	Max	Unit
Bias Input Voltage	2.4	5.5	
IN	0.8	5.5	V
OUT	0.8	$V_{\text{Bias}} - 1.4$	
Junction Temperature, Operating	-40	125	°C
Ambient Temperature	-40	85	



## Electrical Characteristics

( $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$ ,  $V_{Bias}=3.3V$ ,  $I_{OUT}=1mA$ ,  $C_{IN}=1.0\mu F$ ,  $C_{OUT}=2.2\mu F$ ,  $T_A = 25^\circ C$  unless otherwise specified.)

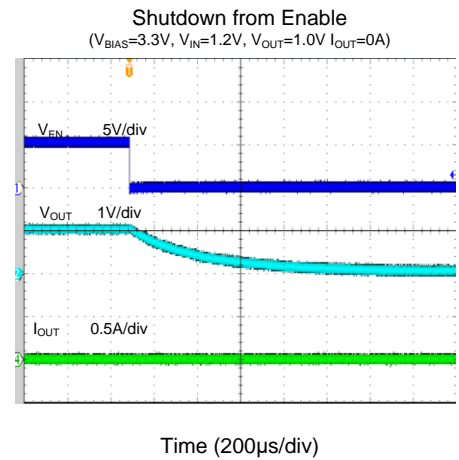
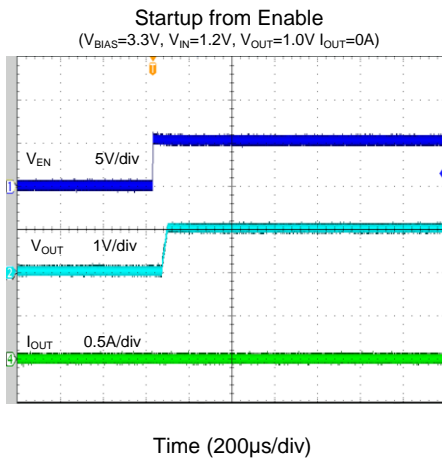
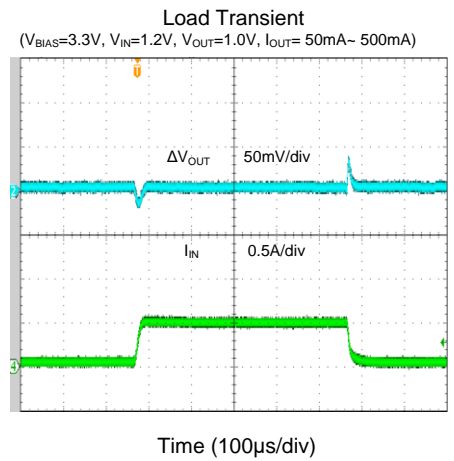
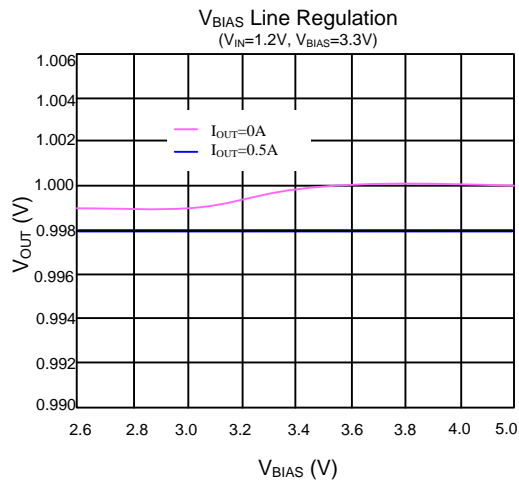
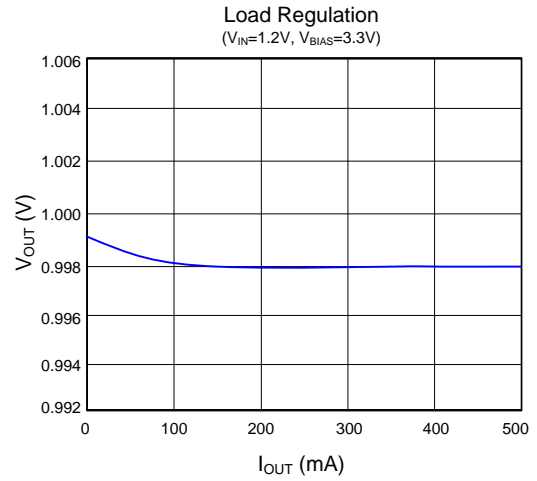
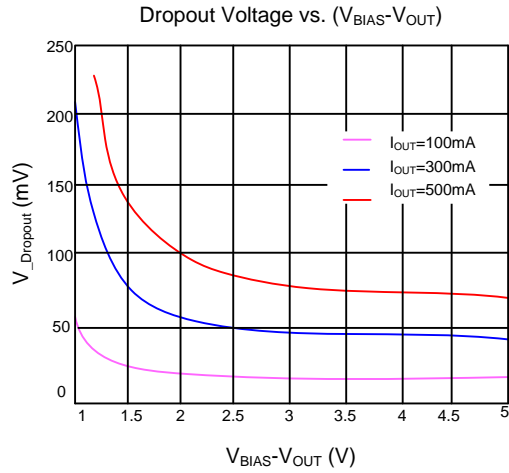
Parameter	Symbol	Test Conditions	Min	Typ.	Max	Unit
Input Voltage Range	$V_{IN}$		$V_{OUT}+V_{DO}$		5.5	V
Bias Input Voltage	$V_{Bias}$		2.4		5.5	V
Bias Supply Current	$I_{Bias}$			110		$\mu A$
Bias Shutdown Current	$I_{SD}$	$V_{EN}=0$		0.1	1	$\mu A$
Feedback Reference Voltage	$V_{REF}$		0.792	0.8	0.808	V
Current Limit	$I_{LIM}$		500			mA
Load Regulation	$V_{LOAD}$	$I_{OUT}: 1mA\sim 500mA$		2		mV
$V_{Bias}$ Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{Bias}}$	2.7 V or ( $V_{OUT(NOM)} + 1.6 V$ ), whichever is greater < $V_{Bias} < 5.5 V$		0.01		%/V
Dropout Voltage	$V_{DO}$	$I_{OUT}=500mA$		90		mV
Ripple Rejection	$PSRR_{(VIN)}$	$V_{IN}$ to $V_{OUT}$ , $f = 1 kHz$ , $I_{OUT} = 150mA$ , $V_{IN} \geq V_{OUT} + 0.5 V$		70		dB
	$PSRR_{(VBias)}$	$V_{Bias}$ to $V_{OUT}$ , $f = 1 kHz$ , $I_{OUT} = 150mA$ , $V_{IN} \geq V_{OUT} + 0.5 V$		70		dB
Output Voltage Temperature Coefficient	$\frac{\Delta V_{OUT}}{\Delta T}$	$I_{OUT}=100mA$ $-40^\circ C \leq T \leq 85^\circ C$		$\pm 100$		ppm/ $^\circ C$
Output Noise Voltage	$V_N$	$V_{IN}=V_{OUT}+0.5V$ , $V_{OUT}=1V$ , $f=10Hz$ to 100kHz		40		$\mu V_{RMS}$
Discharge Resistor	$R_{Discharge}$			130		$\Omega$
EN Rising Threshold	$V_{ENH}$		1.0			V
EN Falling Threshold	$V_{ENL}$				0.4	V
Thermal Shutdown Temperature	$T_{SD}$			150		$^\circ C$
Thermal Shutdown Hysteresis	$T_{HYS}$			20		$^\circ C$

**Note 1:** Stresses beyond the “Absolute Maximum Ratings” may cause permanent damage to the device. These are stress ratings only. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

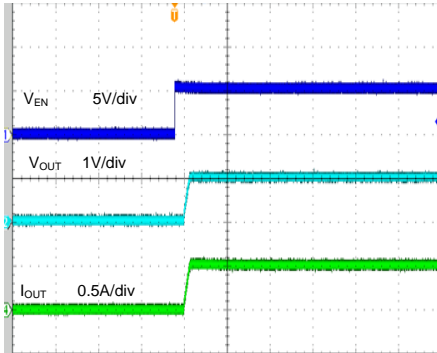
**Note 2:**  $\theta_{JA}$  of SY20733BSCC is measured in the natural convection at  $T_A = 25^\circ C$  on a two-layer Silergy evaluation board.  $\theta_{JC}$  measurement. Paddle of DFN 1.2x1.2-6 package is the case position for SY20733BSCC.

**Note 3:** The device is not guaranteed to function outside its operating conditions.

## Typical Performance Characteristics

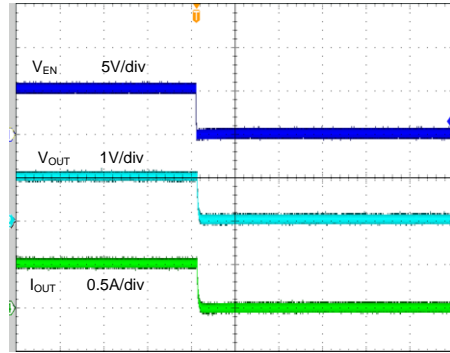


**Startup from Enable**  
 ( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=500mA$ )



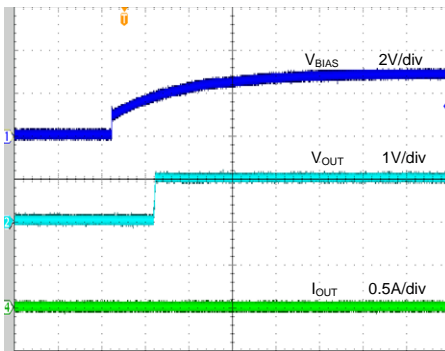
Time (200 $\mu$ s/div)

**Shutdown from Enable**  
 ( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=500mA$ )



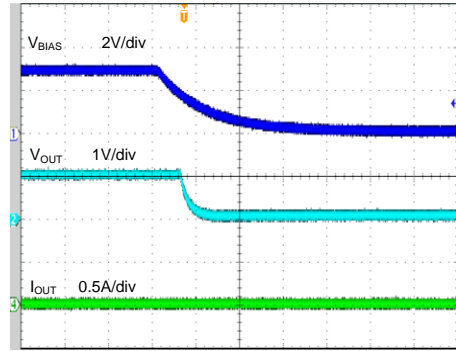
Time (200 $\mu$ s/div)

**Startup from  $V_{BIAS}$**   
 ( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=0A$ )



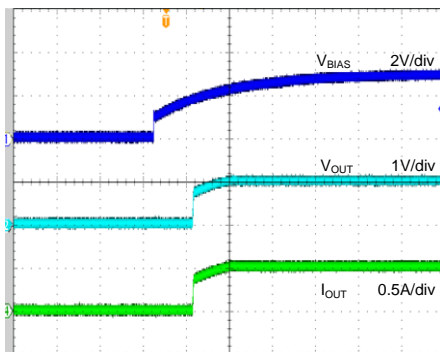
Time (2ms/div)

**Shutdown from  $V_{BIAS}$**   
 ( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=0A$ )



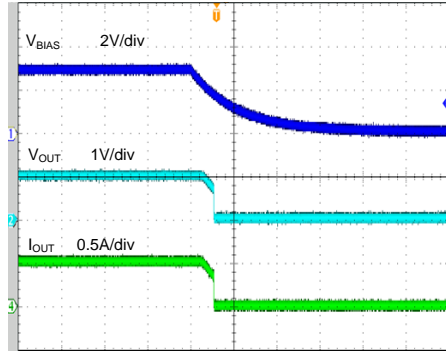
Time (2ms/div)

**Startup from  $V_{BIAS}$**   
 ( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=500mA$ )



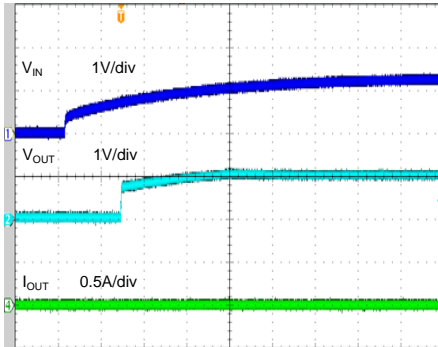
Time (2ms/div)

**Shutdown from  $V_{BIAS}$**   
 ( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=500mA$ )



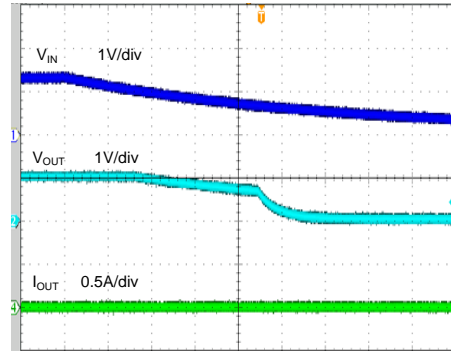
Time (2ms/div)

Startup from  $V_{IN}$   
( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=0A$ )



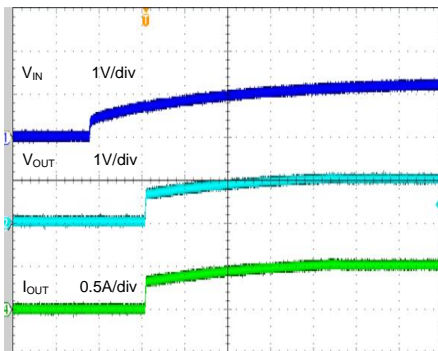
Time (800us/div)

Shutdown from  $V_{IN}$   
( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=0A$ )



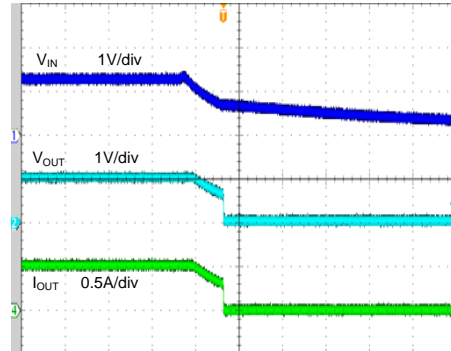
Time (800us/div)

Startup from  $V_{IN}$   
( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=500mA$ )



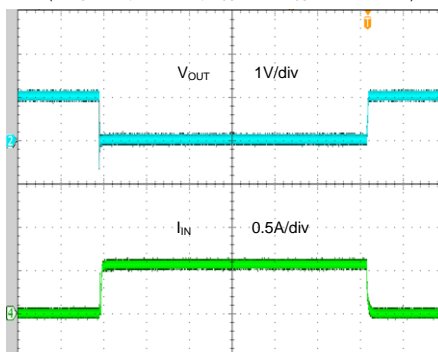
Time (800us/div)

Shutdown from  $V_{IN}$   
( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=500mA$ )



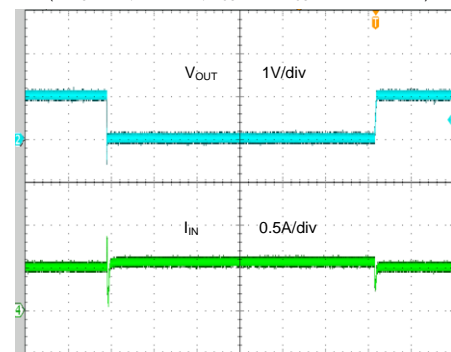
Time (800us/div)

Hard Short Protection  
( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=0A$  to short)

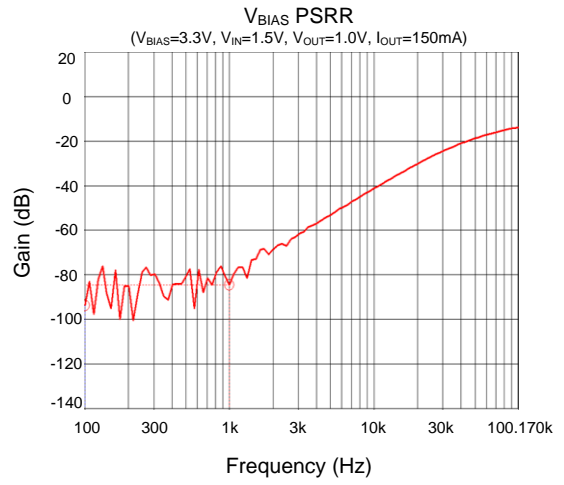
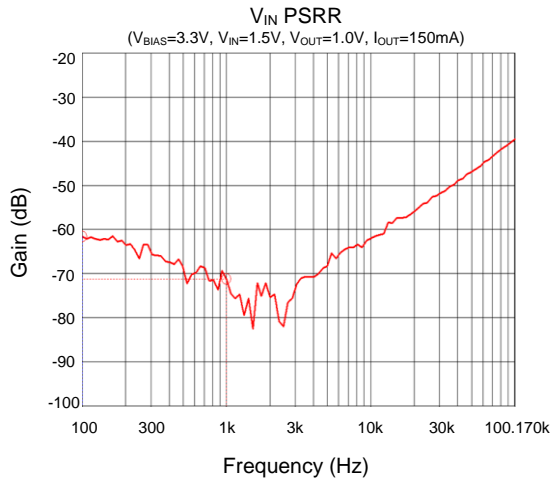


Time (800us/div)

Hard Short Protection  
( $V_{BIAS}=3.3V$ ,  $V_{IN}=1.2V$ ,  $V_{OUT}=1.0V$   $I_{OUT}=0.5A$  to short)



Time (800us/div)



## Application Information

The SY20733B is a low dropout LDO regulator with a compact DFN1.2x1.2-6 package, capable of delivering up to 500mA output current.

### Input Capacitor $C_{IN}$ :

A 1 $\mu$ F decoupling capacitor is recommended between the input and ground pins. A typical X5R or better grade ceramic capacitor with a 6V rating is recommended for most applications.

### Output Capacitor $C_{OUT}$ :

The SY20733B is designed to operate using low equivalent series resistance (ESR) ceramic capacitors. This forms a zero to provide phase lead which is required for loop stability. A 2.2 $\mu$ F input capacitor with 10m $\Omega$  to 50m $\Omega$  ESR range can be used in this application. Higher capacitance values help to improve transient response.

Place the input and output capacitors as close as practical to the input and output pins to ensure stable operation.

### Bias Capacitor $C_{Bias}$ :

A 0.1 $\mu$ F decoupling capacitor is recommended between the bias and GND pins. Place the capacitor as close as practical to the device to achieve the best decoupling performance.

### No Load Stability:

The device will remain stable and in regulation with no external load. This is especially important in CMOS RAM keep-alive applications.

### Dropout Voltage:

Keep  $V_{Bias}$  higher than  $V_{OUT} + 1.4V$ . Decrease  $V_{IN}$  until  $V_{OUT}$  starts to decrease. The value for  $V_{IN}-V_{OUT}$  is defined as  $V_{IN}$  dropout voltage. The  $V_{IN}$  dropout voltage is the regulator's minimum  $V_{IN}-V_{OUT}$ :

$$V_{DROPOUT} = V_{IN} - V_{OUT} = R_{DS(ON)} \times I_{OUT}$$

### Current Limit:

The internal current-limit circuit protects the LDO against transient high-load current faults. During an overload event, the minimum current limit is 500mA.

### Short-Circuit Protection:

The current through the device increases very rapidly during a short circuit event. When a short circuit is detected by comparing the current through the device with the current limit threshold, the current is reduced to approximately 0.5A. Operating in current limit can trigger the integrated thermal shutdown protection circuit. The output turns on and off when thermal shutdown is reached until the temperature drops below  $T_{SD} - T_{HYS}$ .

### Thermal Considerations:

The SY20733B can source a current of up to 500mA over the full operating junction temperature range. However, the maximum output current must be derated at a higher ambient temperature to limit junction temperature to a maximum of 125°C. The junction temperature must be within the operating range specified under all operating conditions. The LDO power dissipation depends on the input-to-output voltage difference and load current.

The dissipated power,  $P_D$ , can be calculated using the following equation:

$$P_D = (V_{IN} - V_{OUT})I_{OUT}$$

The operating junction temperature can be estimated by using the following formula:

$$P_{D_{MAX}} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

Where  $T_{J(MAX)}$  is the maximum junction temperature of die (125°C) and  $T_A$  is the maximum ambient temperature.

## PCB Layout Guide

Good board layout practices must be used for stable operation, and a large PCB copper area can improve the thermal performance. The input and output capacitors must be directly connected to the device's input, output and ground pins using traces with no other currents flowing through them. Place  $C_{IN}$  and  $C_{OUT}$  near the device with short traces to the IN, OUT, and ground pins.

Below is the recommended PCB layout example:

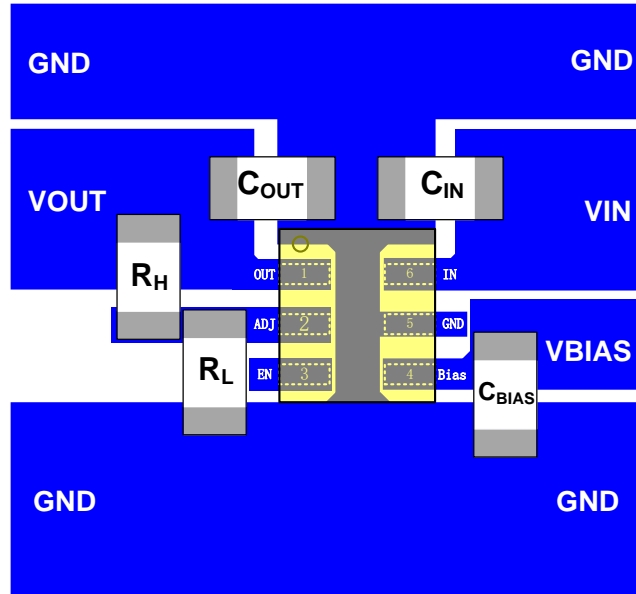
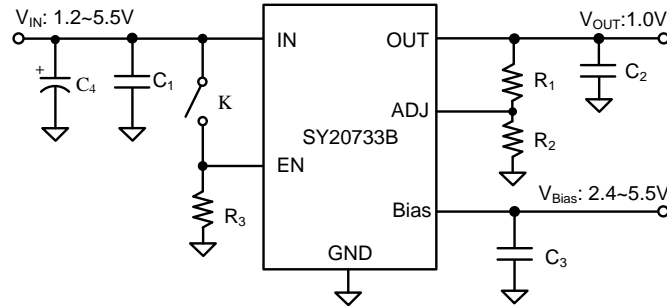


Figure 4. PCB Layout Example

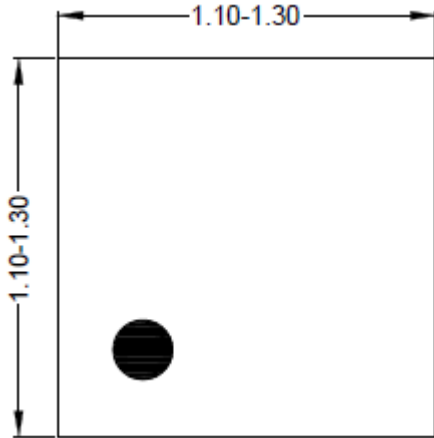
## Application Schematic ( $V_{OUT} = 1.0V$ )



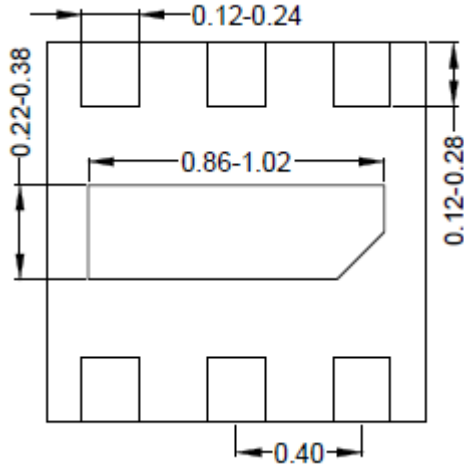
## BOM List

Reference Designator	Description	Part Number	Manufacturer
C <sub>1</sub>	1.0 $\mu$ F/25V, 0603, X5R	C1608X5R1E105K	TDK
C <sub>2</sub>	2.2 $\mu$ F/16V, 0603, X5R	C1608X5R1C225K	TDK
C <sub>3</sub>	0.1 $\mu$ F/50V, 0603, X5R	C1608X5R1H104K	TDK
C <sub>4</sub>	100 $\mu$ F/16V (electrolytic capacitor)		
R <sub>1</sub>	49.9k $\Omega$ , 1%, 0603		
R <sub>2</sub>	200k $\Omega$ , 1%, 0603		
R <sub>3</sub>	1M $\Omega$ , 0603		

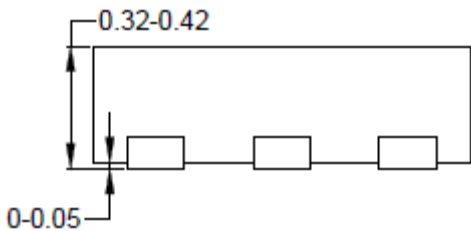
**DFN1.2x1.2-6 Package Outline Drawing**



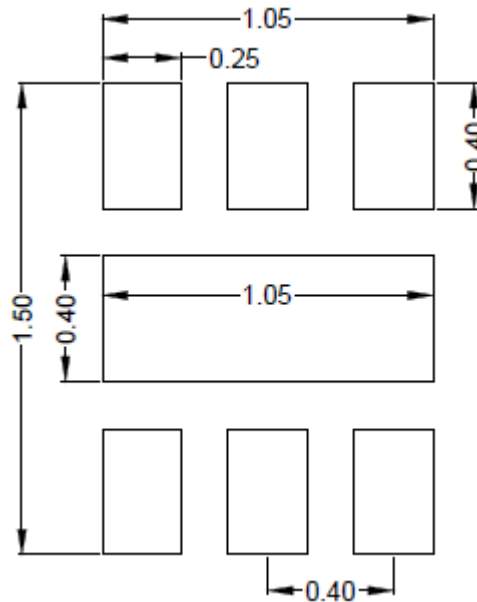
**Top View**



**Bottom View**



**Side View**

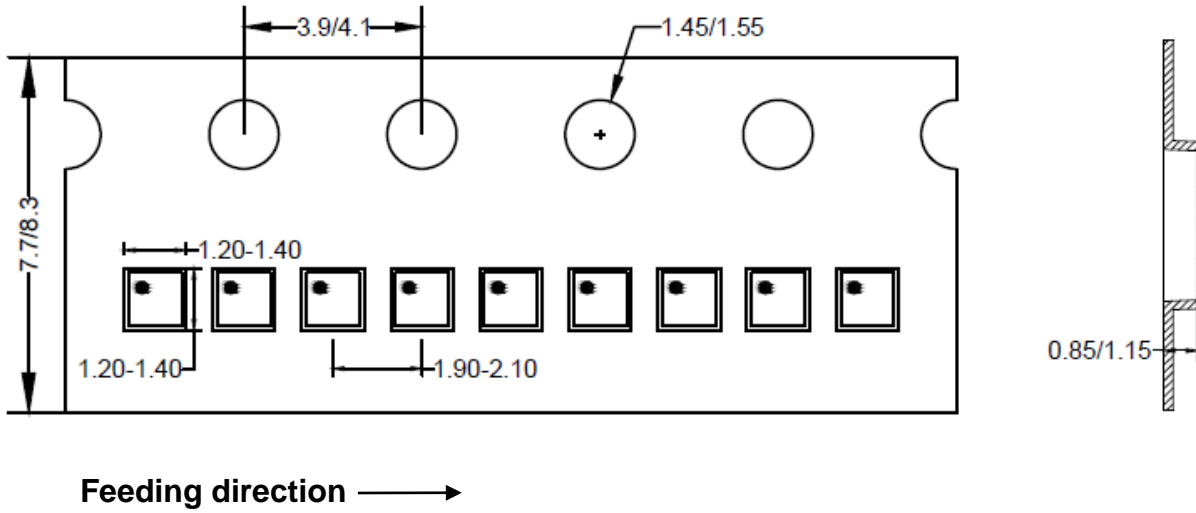


**Recommended PCB Layout  
(Reference Only)**

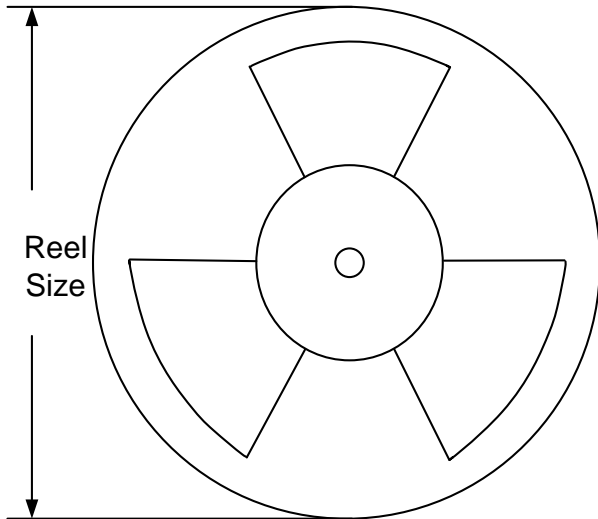
*Note: All dimensions are in millimeters and exclude mold flash and metal burr.*

## Taping & Reel Specification

### 1. DFN1.2x1.2 Taping Orientation



### 2. Carrier Tape & Reel Specification for Packages



Package type	Tape width (mm)	Pocket pitch(mm)	Reel size (Inch)	Trailer length(mm)	Leader length (mm)	Qty per reel
DFN1.2x1.2	8	4	7"	400	160	5000

### 3. Others: NA



## Revision History

The revision history provided is for informational purposes only and is believed to be accurate; however, it is not warranted. Please reference the latest revision.

Date	Revision	Change
Apr. 17, 2026	Revision 1.0a	Fixed a typo in tape and reel information (the actual Pocket pitch is 4mm)
Sep. 25, 2023	Revision 1.0	Language improvements for clarity.
Mar. 21, 2019	Revision 0.9B	Qty per reel change from 10000 to 5000
Mar. 20, 2018	Revision 0.9A	1. Update in "Absolute Maximum Ratings" a. Change from "All pins ----- 6.0V" to "IN, OUT, Bias, EN, ADJ ----- -0.3V to 6.0V". b. Change from "Junction Temperature Range ----- 150°C" to "Junction Temperature Range ----- -40°C to 150°C". 2. Update in "Recommended Operating Conditions" Add "IN ----- 0.8V to 5.5V OUT ----- 0.8V to V <sub>Bias</sub> -1.4V". 3. Update in "Dropout Voltage" in Page9 Change from "When V <sub>Bias</sub> is high enough" to "Keep V <sub>Bias</sub> is higher than V <sub>OUT</sub> +1.4V".
Apr. 25, 2017	Revision 0.9	Initial Release



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